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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

YES PD

This application is a CON of PCT/FR02/02341 07/04/2002

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

YES PD

FRANCE 0108859 07/04/2001

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 05/03/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY FRANCE	SHEETS DRAWING 1	TOTAL CLAIMS 20	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature <i>Lang</i>	Initials <i>PD</i>		

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## TITLE

Method for reducing free surface roughness of a semiconductor wafer

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT	<input type="checkbox"/> All Fees
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